

Call for Papers
for the
MTT-S International Topical Symposium
on
Technologies for Wireless Applications

To complement the annual International Microwave Symposium, the Microwave Theory and Techniques Society (MTT-S) of the Institute of Electrical and Electronics Engineers (IEEE) is sponsoring a series of International Topical Symposia in areas of special interest to its membership. The first of these Symposia is scheduled to be held 21 to 23 February 1995 in conjunction with INTER COMM 95 in Vancouver, B.C., Canada.

The topic of this symposium, *Technologies for Wireless Applications*, is intended to highlight the application of RF, microwave and millimeter wave technologies to all aspects of wireless communications. Contributions of original work are solicited in the field of wireless applications, including personal communication systems, local and wide area networks, stationary and mobile communication systems, global positioning systems and others. Areas of special interest include, but are not limited to:

- System Design Tradeoffs
- Antenna and Path Design
- Devices and Circuits
- Components for Consumer Products
- High Speed Digital Processing
- Design for Manufacturing
- Design for Testing
- Manufacturing Technologies
- Packaging and Interconnection Technologies.

Prospective authors are requested to submit 10 copies of both, a 50 word abstract and an extended Summary (not to exceed 1000 words) with supporting figures, clearly stating the significant contribution, to be sent to:

Dr. George L. Heiter
c/o LRW Associates
1218 Balfour Drive
ARNOLD, MD 21012, USA

Tel: (410) 647-1591 FAX: (410) 647-5136.

A separate cover sheet should include the name, address, telephone and FAX numbers of the corresponding author.

Deadline for the receipt of papers is 29 July 1994. Notifications to authors of accepted papers will be mailed by 29 August 1994. For the Digest of Papers, an archived and copyrighted publication of the IEEE which will be available at the Symposium, authors are expected to provide a camera ready manuscript by 21 October 1994. (Instructions for its preparation, including a copyright release form, will be provided).